Amphenol®

Server Power
The undisputed leader in interconnect systems for harsh environment applications

Company Introduction

Manufacturing connectors since 1932, we take pride that Amphenol Industrial Global Operations (AIGO) is the undisputed leader in interconnect systems for harsh environment applications. Such applications require a high degree of engineering sophistication and precision manufacturing capability. Innovations such as our RADSOK® contact technology can supply gains of up to 50% in current carrying capability through the same size pin vs traditional contact designs. Connectors utilizing the RADSOK® technology outperform conventional power interconnect products and are a better choice for the high current needs demanded by sophisticated electronics.

AIGO’s product lines consist of rectangular, standard, miniature, fiber optic, EMI/EMP filter and a variety of special application connectors. Additionally, we manufacture value-add flex circuit and cable assemblies. Our global manufacturing facilities include locations in Sidney, NY, Fraser, MI, Midland, TX, Shenzhen and Zhuhai, China, Winnipeg, Canada, and Nogales, Mexico. Our Sidney, NY facility is both ISO9001 certified and qualified to MIL-STD-790 requirements.

The Server Environment

Modern servers are capable of millions of transactions per second. They consume significant amounts of power, and produce tremendous amounts of heat while conducting the high amperage to manage these transactions. Excessive heat can cause malfunctions and irreversible damage to servers while being expensive to manage. Therefore, minimizing temperature rise is a key concern when designing power systems for data centers.

AIGO has industry leading experience engineering high current and high density interconnect solutions. Our RADSOK® technology and our proven engineering experience for harsh environments enable Amphenol Industrial Global Operations to develop optimal solutions for server power interconnect needs.

RADSOK® Technology Advantages

RADSOK’S twisted grid configuration allows for 50% more current to pass through the same size pin, while providing increased reliability, ampacity and cycle durability as well as lower insertion force, T-rise and voltage drop.

HIGH RELIABILITY

Unique RADSOK® design and construction technology create an electrical contact interface that exceeds typical interconnect requirements. Applications in aerospace, medical, industrial, automotive, mining, offshore, and other harsh environments depend on the high reliability of Amphenol’s RADSOK® technology.

• LOW CONTACT ENGAGEMENT/SEPARATION FORCES

The hyperbolic lamella socket contact construction distributes normal forces over a high percentage of the mating pin surface. This creates a smooth, even engagement effort. This force distribution also contributes to excellent performance in vibration applications with resistance to typical fretting corrosion.

• LOW CONTACT RESISTANCE

The large interface area between the socket lamella and pin surface result in very low contact resistance, enabling the RADSOK® contacts’ high current ratings compared to traditional power contact designs.

• HIGH MATING CYCLE DURABILITY

RADSOK® contacts with typical silver plating finishes have demonstrated survival of 20,000 mating cycles. Specialized plating and contact lubricants can extend cycle life to 200,000 matings or higher. Even with continuous exposure to harsh environmental abuse (salt, sand, and high humidity), RADSOK® contacts have been tested to maintain low contact resistance beyond 10,000 mating cycles.

RADSOK® Derating Chart – Temperature vs. Current

Based on single conductors in free air. Wire cross-section same size as pin contact cross-sectional area.
High speed and high density electronics have driven demand for significant increases in the amount of power needed for power to board applications. To meet the need for higher current density interconnects Amphenol Industrial Global Operations developed the RADSOK® Power to Board series of connectors. RADSOK® Power to Board solutions facilitate the distribution of power with higher amperage, while allowing the design engineer to achieve size and weight reductions.

Conventional interconnects are limited in their ability to deliver high current without consuming excessive board surface area. The RADSOK® Power to Board series of connectors incorporates a hyperbolic lamella socket contact construction that provides more contact surface area. The high performance contact enables higher current carrying capabilities with lower temperature rises than traditional contact systems.

Amphenol’s RADSOK® Power to Board product line offers many options for delivering high current and single-point connections to the PCB. Please contact your Amphenol Industrial representative for product extensions and custom applications.

RADSERT™’s compact footprint design can deliver up to 120A of current to the board. The high current density and small surface area connection provides flexibility of board design. RADSERT™ contacts are available in either press-fit or solder termination.

RADSOK® RADSERT™
- High power to board interconnect in a small package
- Hyperbolic socket design ensures many points of contact
- Solder version or pre-loaded RADSERTs are installed during board fabrication
- RADSERT™ 2.4mm (35A), 3.0mm (60A), 3.6mm (70A) 4.8mm (100A) & 6.0mm (120A)
- No special crimp tools required
- No threaded fasteners
- Eliminates risk of PTH cracking or delamination in board
- Faster through-put
- Available in Super Twist (ST)
- RoHS compliant

RADSOK® PGY™
- Orthogonal, co-planar & right angle connections between PCBs or PCB to bus bar
- Compact footprint
- Legs of the PGY distribute high power evenly
- 2.4mm carries up to 35 Amps
- 3.0mm carries up to 60 Amps
- 3.6mm carries up to 70 Amps
- 4.8mm carries up to 100 Amps
- 5.7mm carries up to 120 Amps
- No threaded fasteners
- No special crimp tools required
- Faster through-put
- Available in Super Twist (ST)
- RoHS compliant

RADSOK® PowerBlok™
- High power to board interconnect in a small package
- Compact footprint 15.7mm x 15.7mm
- RADSOK® 2.4mm, 3.0mm & 3.6mm (35A-60A-70A)
- Backplane power interface with compliant pins for power
- Touchproof cover
- Hyperbolic socket design ensures many points of contact
- Reduces failure modes, eliminates burn outs
- No threaded fasteners
- No special crimp tools required
- Eliminates possible stress fractures in board
- Faster through-put
- Available in Super Twist (ST)
- RoHS compliant

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<thead>
<tr>
<th>Part Number</th>
<th>Size</th>
<th>Amps</th>
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**SURLOK™**

- High current rating, high ampacity in a smaller package
- High reliability; meets or exceeds the electrical performance of bolt-on compression lugs
- Easy field installation - crimp with standard color-coded dies (Udie and 4 indenter). No torque wrenches required.
- Integral locking feature plus locking cap

**RADSOK® technology** boosts the ampacity by 50% or more compared to mil-spec contacts. RADSOK® contacts provide the advantages of low insertion force and high cycle durability.

**RoHS compliant**

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**AMPHE-GTR**

- Utilizes RADSOK® high amperage socket contact technology, enabling increased current ratings to 120A on individual contacts.
- Currently available in shell size 32 with 4 or 5 conductors.
- The connector type is a straight plug which houses RADSOK® sockets and a box mount receptacle with pin contacts.
- Compression (setscrew) wire termination to the 4/6AWG or 8/10AWG conductors allows easy field replacement of pin or socket contacts, or complete plug and receptacle assemblies, without requiring specialized tooling.
- Meets same performance levels as GT Series.
- Listed to UL/CUL 1977/1682/817 Standard, control number 19VP.

- Utilizes a standard PG adapter watertight strain relief on the plug to achieve IP67 seal rating.
- Flammability rated to UL94V-0.

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**AMPHE-PD**

Technical Specifications: 3.6mm is UL rated 69 amps (6 AWG). CSA rated 55 Amps (6 AWG). 5.7mm (non-UL) is rated for 120 amps. Molded from UL94V-0 thermoplastic (self extinguishing). Meets RoHS and UL-94V-0 guidelines. 2-pole DC Power interconnect in about 1 square inch (3.6mm version) and 1.75 inch square (5.7mm version). Passes UL and TUV finger proof design standards.

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<table>
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<tr>
<th>Wire Size</th>
<th>RADSOK® Size</th>
<th>Current Rating</th>
<th>Surlok Assembly Part Number</th>
<th>Lug Only Part Number</th>
<th>Conductor Max. Dia.</th>
<th>Crimp Code</th>
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<td>PSL-368K</td>
<td>PSL-368</td>
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<td>6 AWG</td>
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<td>100 Amps</td>
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<td>300 Amps</td>
<td>PSL-1030K</td>
<td>PSL-1030</td>
<td>0.44 in.</td>
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Notes: (1) Surlok® Assembly contains the wire compression lug, plus a two-piece dielectric clamped housing. Housing is available in black color as standard. Contact Amphenol Industrial for alternate color. (2) Lug only specifies the wire compression RADSOK® Surlok, less the plastic housing.

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**The Future of RADSOK® R4 Technology**

The R4 version of the RADSOK® represents the culmination of three years of research and development in laser welding copper based alloys. This innovative approach to construction of the RADSOK® cartridge provides benefits previously unavailable in the product line.

- Packaging restraints are reduced due to a smaller outside diameter of the component
- Automated assembly processes result in less manufacturing variability
- Better consistency in performance
- Better mechanical strength in a welded assembly
- Lower voltage drop/resistance
- Low temperature rise
RADSOK® RadFin™

RADSOK® RadFin™ was designed to address the need for amperes greater than 100A while maintaining a small footprint for PCB applications. Another unique feature of the RadFin™ is its ability to act as a great heat dissipating connector. This dramatically helps reduce T-rise with minimal air-flow required.

- 100A to 300A
- Small form factor, 6.0mm, 8.0mm & 10.0mm
- Also offered with a plastic protective cover and male pin
- Solder tail (Press fit optional)
- 1000A surge – 2 seconds
- Operating temperature can meet -40C to +125C
- Dielectric withstanding voltage is 2000 Vac RMS
- Insulation resistance can meet 5000 M Ohms
- 500 mating cycles – minimum
- Insertion force : Max 7 lbs.; Separation force: Min 1.5 lbs.
- UL94-V0 (self extinguishing)

Technical Data

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<tr>
<th>DC Voltage Rating</th>
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<td>DC Current Rating</td>
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<tr>
<td>Flammability Rating</td>
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<td>Operating Temperature Range</td>
<td>-40º C to 125º C</td>
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<tr>
<td>Mating Cycles</td>
<td>500</td>
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RADSOK® Super Twist

**Design Background**

The RADSOK® Super Twist contact was developed to enable greater radial misalignment tolerance, or “float,” in drawer and blindmate applications. Greater radial gatherability is achieved in the Super Twist (ST) contact by adding additional “twist” to a larger RADSOK® contact. Using a larger O.D RADSOK® creates additional I.D clearance for the mating male pin while maintaining electrical and mechanical performance.

**Benefits of using Super Twist RADSOK®**

Radial misalignment tolerance is significantly increased. The RADSOK® Super Twist contacts are used in applications where mechanical system tolerance is difficult to control in manufacturing and/or assembly, for example, mating multiple positions on a bus bar with poor true positioning to a PCB or pluggable power supply assembly.

RADSOK® RadStack™

RADSOK® RadStack™ was designed to address the need for high current and small foot prints for PCB mezzanine applications.

- 35A to 120A
- Low-profile, 10mm to 50mm in any size increment
- Press fit attachment 35A to 120A
- 1000A surge – 2 seconds
- Operating temperature can meet -40C to +125C
- Dielectric withstanding voltage is 2000 Vac RMS
- Insulation resistance can meet 5000 M Ohms
- Mezzanine heights from 10mm+
- 500 mating cycles – minimum
- Insertion force : Max 4.5 lbs.; Separation force: Min 0.62 lbs. (Each pin )
- UL94-V0 (self extinguishing)

RADSOK® PowerBlok™ WTB (Wire to Board)

- 35A rated single point of contact
- Low profile right angle exit less than ½ inch mated height
- 12-14 AWG crimp contact with insulated housings
- Board receptacle part number: 10-707991-000
- Wire applied right angle pin with latching housing part number: 10-729455-000
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